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08-06-01

PATENT

Docket No. JCL A7354

Date: 8-3-2001

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ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231
ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Chih Yuan Huang, Chin Hsiang Lin

For: METHOD FOR FABRICATING N-TYPE DOPED POLYCRYSTALLINE SILICON

Enclosed are:

- ☒ Specification 10 pages.
- ☒ 2 Sheets of drawings
- ☒ Recordation Form Cover sheet with 2 pages assignment.
- ☐ A certified copy of Taiwan Patent Application No. dated .
- ☒ **SIGNED** declaration and power of attorney.
- ☒ Return Prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$710.00	\$710.00
Total Claims	14 — 20 = 0 ×		\$18.00	\$0.00
Independent Claims	3 — 3 = 0 ×		\$80.00	\$0.00
If application contains any multiple dependent claim (s), then add			\$270.00	\$0.00
TOTAL FILING FEE				\$710.00

- ☒ A check in the amount of \$710.00 cover the filing fee is enclosed.
- ☒ A check in the amount of \$40.00 to cover the assignment recording fee.
- ☒ A duplicate copy of this sheet is enclosed.

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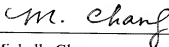
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Docket No. : JCLA7354
Applicant(s) : Chih Yuan Huang, Chin Hsiang Lin
For : METHOD FOR FABRICATING N-TYPE
DOPED POLYCRYSTALLINE SILICON
"Express Mail" : EL 800769121 US
Mailing Label No.
Date of Deposit : August 3, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 10 pages, 2 sheets of drawings; **SIGNED**
Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and
Assignment 3 pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to
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Michelle Chang